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SiC Schottky Barrier Diode

TRS6E65C

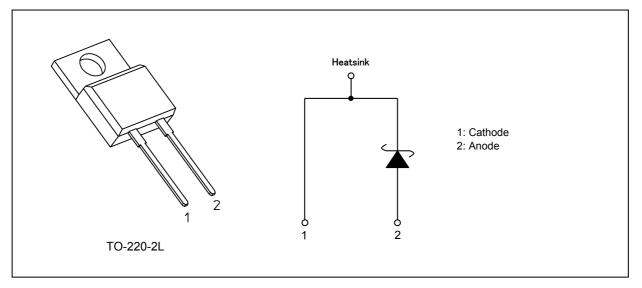
1. Applications

- Power Factor Correction
- Solar Inverters
- Uninterruptible Power Supplies
- DC-DC Converters

2. Features

- (1) Forward DC current: $I_{F(DC)} = 6 A$
- (2) Repetitive peak reverse voltage: $V_{RRM} = 650 V$

3. Packaging and Internal Circuit



4. Absolute Maximum Ratings (Note) (Unless otherwise specified, $T_a = 25 \text{ °C}$)

| Characteristics | Symbol | Note | Rating | Unit |
|---------------------------------|--------------------|----------|------------|------------------|
| Repetitive peak reverse voltage | V _{RRM} | | 650 | V |
| Forward DC current | I _{F(DC)} | | 6 | А |
| Forward pulse current | I _{FP} | (Note 1) | 80 | |
| I ² t limit value | l²t | (Note 2) | 4.5 | A ² s |
| Junction temperature | Tj | | 175 | °C |
| Storage temperature | T _{stg} | | -55 to 175 | |
| Mounting torque | TOR | | 0.6 | N·m |

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: t = 100 µs

Note 2: f = 50 Hz

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5. Thermal Characteristics

| Characteristics | Symbol | Test Condition | Max | Unit |
|--|----------------------|----------------|-----|------|
| Thermal resistance (junction-to-case) | R _{th(j-c)} | _ | 2.8 | °C/W |
| Thermal resistance (junction-to-ambient) | R _{th(j-a)} | — | 89 | |

6. Electrical Characteristics (Unless otherwise specified, Ta = 25 °C)

| Characteristics | Symbol | Test Condition | Min | Тур. | Max | Unit |
|---------------------------------|---------------------|--|-----|--------|------|------|
| Peak forward voltage | V _{FM(1)} | I _F = 3 A (pulse measurement) | _ | 1.22 | _ | V |
| | V _{FM(2)} | I _F = 6 A (pulse measurement) | _ | 1.50 | 1.70 | |
| Repetitive peak reverse current | I _{RRM(1)} | V _{RRM} = 300 V (pulse measurement) | _ | 0.0008 | — | μA |
| | I _{RRM(2)} | V _{RRM} = 650 V (pulse measurement) | _ | 0.3 | 90 | |
| Junction capacitance | Cj | V _R = 650 V, f = 1 MHz | | 35 | | pF |

7. Marking

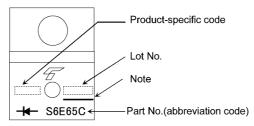


Fig. 7.1 Marking

Note: A line under a Lot No. identifies the indication of product Labels.

[[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product.

The RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

| Abbreviation Code | Part Number | |
|-------------------|-------------|--|
| S6E65C | TRS6E65C | |

8. Usage Considerations

(1) The absolute maximum ratings are rated values that must not be exceeded during operation, even for an instant. The following are the recommended general derating methods for designing a circuit board using this device.

 V_{RRM} : V_{RRM} has a temperature coefficient of 0.1 %/°C.

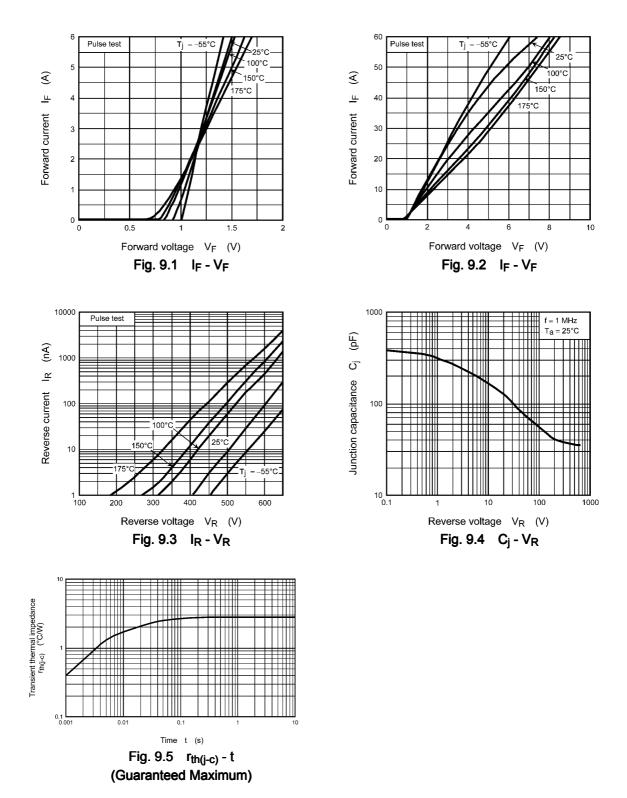
Take this coefficient into account when designing a circuit board that will be operated in a low-temperature environment.

 $I_{F(DC)}$: We recommend that the worst-case current be no greater than 80 % of the absolute maximum rating of $I_{F(DC)}$ and that the worst-case junction temperature, T_i , be kept below 140 °C.

- $I_{FP} \hbox{:} \quad \mbox{We recommend that the worst-case current be no greater than 80 \% of the absolute maximum rating of I_{FP} and that the worst-case junction temperature, T_j, be kept below 140 °C.}$
- I²t: This rating specifies a non-repetitive limit value.This only applies to an abnormal operation, which seldom occurs during the lifespan of a device.
- T_j : Derate device parameters in proportion to this rating in order to ensure high reliability. We recommend that the junction temperature (T_j) of a device be kept below 140 °C.
- (2) For other design considerations, see the Rectifiers databook or the Toshiba Semiconductor website.

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9. Characteristics Curves (Note)



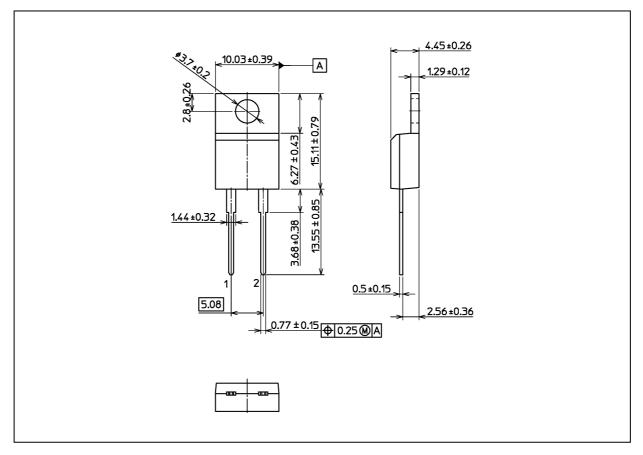
Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



TRS6E65C

Package Dimensions

Unit: mm



Weight: 1.9 g (typ.)

| | Package Name(s) |
|---------------------|-----------------|
| TOSHIBA: 2-10AA1A | |
| Nickname: TO-220-2L | |

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